

Key Features & Benefits

- 28 VDC, 32 VDC and 36 VDC output voltage preset via VID pins
- Margining via I²C
- Active current/load sharing
- Wide input voltage range 85-264 VAC
- Highly-efficient topology yields 89% at 230 VAC
- 1U high: 5.6" x 1.6" x 12" cassette
- Input fuse protected I²C
- interface status and control
- High density design:13.4W/in³
- Up to 4500 W in a 1U-high, 19-inch wide rack
- Standby voltage 5 VDC/1A
- Adjustable output voltage
- Overtemperature, output overvoltage and output overcurrent protection
- ORing circuit for true redundant operation
- Status LEDs: AC OK, DC OK, Fan Fail/Overtemperature Fail
- Auto select power limits

FXP1500-32G AC-DC Power Supply

FXR-3-32G Power Shelf

The FXP1500-32G is a 1500 watt, power factor corrected (PFC) front-end, which provides a user-adjustable 32 VDC (26-38 VDC range) main output for test & measurement, RF amplifiers and transmitters, factory automation, semiconductor equipment, and other distributed power applications. The FXP1500-32G provides for true hot-swap with AC and DC connections at the rear of the model and can be used for redundant system applications. Its very small dimensions allow configuration of up to three units in a 1U rack (up to 4500 W).² The highly-efficient thermal design with internal fan cooling permits its use in wide operating voltage and temperature ranges to provide very high reliability.

Status information is provided with front panel LEDs, logic signals, and via the I²C management interface. In addition, the I²C bus can enable the power supply, control the fan speed, adjust the output voltage, and set the output current limit.

The FXP1500-32G meets international safety standards and displays the CE-Mark for the European Low Voltage Directive (LVD).

Applications

- Test & Measurement,
- RF Amplifiers & Transmitters
- Factory Automation
- Semiconductor & LD-MOS Based Equipment
- other Distributed Power Applications

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Model Selection

	INPUT VOLTAGE	OUT	PUT 1	OUTF	PUT 2	RATED	COMPATIBLE	
MODEL	VAC AUTO SELECTED ¹	Vo nom VDC	<i>l</i> o max ADC	Vo nom VDC	<i>l</i> o max ADC	POWER W	SHELF ²	
FXP1500-32G	85 – 264	32	46.9	5	1	1505 ³	FXR-3-32G	

Absolute Maximum Ratings

Stress in excess of the absolute maximum ratings may cause performance degradation, adversely affect long-term reliability, or cause permanent damage to the converter.

PARAMETER	CONDITIONS/DESCRIPTION	MIN	MAX	UNIT
Input voltage	Continuous Transient, 60 ms max.		264 300	VAC VAC
Operating ambient temperature	V_{min} - V_{max} , k_{nom} , cooling by internal fan 100 % load from 0 to 50°C linear derating to 50% load from 50°C to 70°C	0	70	°C
Storage temperature	Non-Operating	-40	85	°C

Input Specification

Specification is valid for input voltage, load, and temperature ranges, unless otherwise stated.

PARAMETER	CONDITIONS/DESCRIPTION	MIN	NOM	MAX	UNIT
Input Voltage		85	230	264	VAC
Input Frequency		47	50/60	63	Hz
Turn-On Input Voltage	Ramping up	79	-	85	VAC
Turn-Off Input Voltage	Ramping down	70	-	78	VAC
Inrush Current Limitation	115/230 VAC acc. ETS 300 132-1 < 100 ms			50	A_{pk}
Hold-Up Time	After last AC line peak , $V_{\rm a} = 230$ VAC, $P_{\rm o\;nom}$	20			ms
Power Factor	И nom, <i>l</i> o nom	0.95			W/VA
Efficiency	$V_c = 230 \text{ VAC}, V_{O nom}, I_{O nom}, T_c = 25^{\circ}\text{C}$	89	89.5		%
Max Input Current				20	Arms



The available output power is automatically adjusted depending on the input voltage. 1U standard rack FXR-3-32G for FXP1500-32G is available from Bel Power Solutions.

Automatic derating of main output below 108 VAC to: lo max = 37.5 A (1200 W).

Output Specification

Specification is valid for input voltage, load, and temperature ranges, unless otherwise stated.

PARAMETER	CONDITIONS/DESCRIPTION		MIN	NOM	MAX	UNITS
Total Output Voltage Range	Adjustable via T4, T5 pins & I ² C		26		38	VDC
Output Voltage Set Point	Adjustable via T4, T5 pins (LL = 28 V, LH = HL = 32 V, HH = 36 V)			28 32 36		VDC VDC VDC
Output Voltage Trimming	Adjustable via I ² C from any set point. Note : all changes to V _{o1} made via I ² C are volati upon power cycling the PSU	le and are lost	-2		+2	VDC
Overvoltage Protection Latching	28V set point 32V set point 36V set point			35 40 45		VDC VDC VDC
Nominal Current Output 1	$I_{o1\;nom}\;\; @\;\; V_i = 105\; VAC - 264\; VAC, P_o\; 1.5\; kW$ $I_{o1\;nom}\;\; @\;\; V_i = \; 85\; VAC - 105\; VAC, P_o\; 1.2\; kW$	28V set point 32V set point 36V set point 28V set point 32V set point 36V set point		46.9 46.9 41.7 42.9 37.5 33.4		ADC ADC ADC ADC ADC ADC
Nominal Current Output 2	I _{o2 nom} @ Vi = 85 VAC – 265 VAC, P _o 5 W	oot oot point		1.0		ADC
Current Limit Output 1	$I_{01 \text{ max}} @ V_i = 105 \text{ VAC} - 264 \text{ VAC high droop}$ $I_{01 \text{ max}} @ V_i = 85 \text{ VAC} - 105 \text{ VAC high droop}$	hic-cup		48.8 50.8 39.0 41.0		ADC ADC ADC ADC
Current Limit Output 2	$I_{o2 \text{ max}} @ V_i = 85 \text{ VAC} - 265 \text{ VAC}$			1.3		ADC
Static Line Regulation Output 1	Vi min - Vi max, 50 % lo nom		-0.5		0.5	% V _{o nom}
Static Load Regulation Output 1 (Droop Characteristic)	$V_i = 230$ V, 0-100 % $I_{0 \; nom} V_o ; \; full load (46.9 ADC) to no load$		31.68 -1.0	32	13.6 32.32 +1.0	mV/A VDC % V _{o nom}
Dynamic Load Regulation	Load change 1 % <> 100 % lo nom, dl _o /dt =1 Voltage deviation (droop + over- or undershoot Max. recovery time to within 1 % of V _{o1 nom}		-4		+4 2000	% V _{o nom}
Start-Up Time	Time required for output within regulation after initial application of AC-input (V _{i nom} , I _{o nom}) after removal of inhibit (V _{i nom} , I _{o nom})			100	1.5	s ms
Output Voltage Ripple & Noise	$V_{\text{i nom}}$, $I_{\text{o nom}}$, 20 MHz bandwidth V_{o1} V_{o2}				320 50	mV_pp mV_pp
Remote Sense	Total compensation for cable losses				500	mV
Active Current Share	Difference in current between two units for V_{o1} load. Active current share pin with its $1k\Omega$ internenables control of output voltage. Voltage on the proportional to output current, $2V$ at I_{o1nom}	nal impedance			5	ADC

Protection

PARAMETER	CONDITIONS/DESCRIPTION	MIN	NOM	MAX	UNIT
Input Fuse	Not user accessible		2	5AF	
Inrush Current Limitation			with	NTCs	
Output		No-load	d, short circu	it, and overl	oad proof
Overvoltage Protection Latching 1	Absolute		40		V
Over-Temperature Protection	Automatic power shutdown at T_{C}		95		°C



Controls and Indicators

PARAMETER	TYPE ⁴	CONDITIONS/DESCRIPTION
Visual Status Indication	FP	 DC OK (green) AC OK (green) Fan fail & Over-temperature (amber)
I ² C Communication Bus	OC[S1, S2]	 Monitors alarm functions and allows control of specific parameters. Uses standard Philips two wire bus (SCL and SDA signal lines)
I ² C Communication Bus Addressing	OC[T1-T3]	Three lines provide up to 8 separate PSU I ² C addresses
PS Present Pin	OC[U3]	 Used by system to indicate a PSU is installed in a system shelf Contact closure to logic ground (internal pull-down resistor of 1 kΩ)
PS Main Output Remote Shutdown	OC[R1] FP	 TTL compatible signal, inhibited when open contact, high or at TTL logic "1" Signal referenced to logic return (LRTN) Two position switch in series with OC signal (logical AND) allows local enable/disable; "0" Position => PS disabled; "1" Position => PS Enabled
Power Supply OK	I ² C	AC OK & DC OK & no overcurrent & no over-temperature & fans working
DC Current Fail	I ² C	Reports over-current condition on main output, I _{O1}
AC Fail / Power Down Warning	OC[U2] & I ² C	 Provides a warning that the input power has failed at least 5 ms before the output falls out of regulation (<90% V₀₁ set). Open collector signal with 20 mA pull-down capability, referenced to logic return (LRTN). AC fail will go high or open during power fail condition and will go low when input is within the operating range. A Power Fail warning will turn off the front panel green AC OK LED.
DC fail / Output Voltage Fault	OC[U4] & I ² C	 Internal under-voltage and overvoltage supervision of V₀₁. Open collector signal with 20 mA pull-down capability, referenced to logic return (LRTN). DC fail will go high or open if Vo1 < 90% or V₀₁> 110% of V₀₁ set, measured in front of the ORing FETs. Green LED on the front panel indicates normal operation; LED will flash if in parallel operation V₀₁ is OK, but the unit is disabled.
Critical Temperature Warning/Fan Fail	OC[U1] & I ² C	 Indicates the PSU operating temperature has reached [T_{shut-down} – 10K] Indicates if the unit is in over-temperature shutdown. Open collector signal with 20 mA pull-down capability, referenced to logic return (LRTN). The OC-output will go low 100 ms before an over-temperature condition shuts down the unit. An amber LED on the front panel indicates over-temperature or fan fail.
DC Voltage Monitoring	I ² C	Monitors the main output voltage, V_{01} , seen at the output connector. Accuracy is $\pm 1\%$ over setting range and temperature.
DC Current Monitoring	I ² C	Monitors the output current I_{01} : Accuracy \pm 1% over the load range.
Active Current Share Interconnect	OC[R4]	Line must be connected to all paralleled PSUs to allow active current share functionality between units
V ₀₁ Presets	OC[T4,T5]	Output voltage is preset per programming of T4, T5 • T4/T5 = LOW / LOW => V ₀₁ =28VDC • T4/T5 = LOW / HIGH = HIGH / LOW => V ₀₁ =32VDC • T4/T5 = HIGH / HIGH => V ₀₁ =36VDC
V ₀₁ Voltage Trimming (Margining)	I ² C	Output voltage trimming Vo1: ± 2 VDC Setting accuracy over I ² C: \pm 50mV at V ₀₁ nom, \pm 150 mV over setting range
Fan Speed Control	I ² C	Two fan speed levels automatically set depending on the internal temperature. The fan speed can be set to full speed or automatic control via I ² C command.
Fan OK/FAIL	OC[U1] & I ² C	Indicates if the cooling fans are operating or have failed.
Synchronized Startup Pin	OC[R5]	Overcurrent signal which can be used for synchronous startup of units in parallel or to recover from an overload condition.

Abbreviations used:

OC[#] => Hardwired signal accessible at PSU output connector, with pin number reference

=> Provided by devices located on PSU Front panel

I²C

=> Signal provided over I²C communication system.

Detailed I²C information is available from the specific model's I²C Manual found on the Bel Power Solutions web site.

See LED Function table for further details





Environmental, Mechanical & Reliability Specifications

PARAMETER	CONDITIONS/DESCRIPTION	MIN	NOM	MAX	UNIT
Altitude	Operating Non-Operating			10 k 40 k	ASL Ft. ASL Ft.
Relative Humidity,	Operating	10		90	% RH
Non-Condensing	Storage	5		95	% RH
Temperature Coefficient	0 °C to 70 °C (after 15 min warm-up)			0.02	%/K
Shock	IEC/EN 60068-2-27, 11 ms			40	g_{pk}
Sinusoidal Vibration	IEC/EN 60068-2-6 2-8 Hz 8-200 Hz 200-500 Hz		7.5 2 4		mil gpk g _{pk}
Random Vibration	10-2000 Hz		6.15		grms
MTBF	Calculated per Bellcore (SR-332, Issue 1): GB 25°C Demonstrated	230 250			kh kh

Safety Specifications

Maximum electric strength testing is performed in the factory according to EN50514, IEC/EN60950-1 2nd ed. and UL/CSA60950-1 2nd ed. Input-to-output electric strength tests should not be repeated in the field. Bel Power Solutions will not honor any warranty claims resulting from electric strength field tests.

PARAMETER	CONDITIONS/DESCRIPTION	MIN	NOM	MAX	UNIT
Agency Approvals	Approved to the latest edition of the following standards: CSA/UL60950-1, EN60950-1 and IEC60950-1; CE Mark for LVD				
Insulation Safety Rating	Input to case Input to output Output to case		Basic Reinforced Functional		
Electric Strength Test Voltage	Input to case Input to output Output to case Output 1 to output 2	2.121 Note ⁶ 0.1 0.1			kVDC kVDC kVDC kVDC

Subassemblies are pre-tested with 4.2 kVDC in accordance with EN50514 and IEC/EN60950-1 2nded.

EMC Specification

DESCRIPTION	CRITERION
IEC/EN 61000-4-2, level 4 (contact/air)	8/15 kV, Performance criterion B
IEC/EN 61000-4-3, level 3	10 V/m, Performance criterion A
IEC/EN 61000-4-4, level 3 (L/L, L/E)	2 / 1 kV, Performance criterion B
IEC/EN 61000-4-5, level 3 (L/L, L/E)	1 / 2 kV, Performance criterion B
IEC/EN 61000-4-11 Dip 30 %, 100 ms Dip 30 %, 200 ms Dip 60 %, 20 ms Dip 60 %, 100 ms Dip > 95 %, 20 ms Dip > 95 %, 100 ms	Performance criterion A Performance criterion B Performance criterion A Performance criterion B Performance criterion A Performance criterion B
IEC/EN 61000-4-6	10 VAC, AM 80 %, 1 kHz Performance criterion A
CISPR 22/EN 55022/EN 61204	Class B
CISPR 22/EN 55022/EN 61204	Class A
IEC/EN 61000-3-2	Class B
IEC/EN 61000-3-3	Pass
SEMI F47-0200 (High Line 230V)	Pass
	IEC/EN 61000-4-2, level 4 (contact/air) IEC/EN 61000-4-3, level 3 IEC/EN 61000-4-4, level 3 (L/L, L/E) IEC/EN 61000-4-5, level 3 (L/L, L/E) IEC/EN 61000-4-11 Dip 30 %, 100 ms Dip 30 %, 200 ms Dip 60 %, 20 ms Dip 60 %, 100 ms Dip > 95 %, 20 ms Dip > 95 %, 100 ms IEC/EN 61000-4-6 CISPR 22/EN 55022/EN 61204 CISPR 22/EN 55022/EN 61204 IEC/EN 61000-3-2 IEC/EN 61000-3-3



Output Connector Pinning and Signal Specification

OUTPUT CONNECTOR DESCRIPTION	OC PIN#	ТҮРЕ	SIGNAL REFERENCE	LOW LEVEL HIGH LEVEL	V MAX I MAX
Over-temperature / Fan Fail	U1	OC-output, protected by 16 V Zener diode		<0.4 V @ 20 mA Pull up	15 V 20 mA
AC Fail / Power Down Warning	U2	and a 10Ω resistor in series	LGND	<0.4 V @ 20 mA Pull up	15 V 20 mA
Power Supply Present	U3	1KΩ Resistor connected to logic GND	LGND	Open Pull up	10 V 10 mA
DC Fail / Output Voltage Fault	U4	OC-output, protected by 16 V Zener diode and a 10Ω resistor in series	LGND	<0.4V @ 20 mA Pull up	15 V 20 mA
Internal Ground (INT GND)	U5	Used only for ADDRx and V_{01} set. Do not connect the internal grounds in systems with several units.	Connected to V ₀₁ - line before the output filter	-	-
ADDR0 I2C Address Bus	T1				
ADDR1 I2C Address Bus	T2	High internal 10 KO Bilts EV . Logic 1			
ADDR2 I2C Address Bus	Т3	High = internal 10 KΩ PU to 5V=> Logic 1	INT GND	Logic 1	5V
VO1 set	T4	Low = connect to INT GND => Logic 0		Logic 0	0V
VO1 set	T5				
SDA, I2C Serial Data Line	S1	I ² C compatible signal referenced to logic	1.0015	Logic 1	5V
SCL, I2C Serial Clock Line	S2	GND 5 V or 3.3 V logic	LGND	Logic 0	0V
Auxiliary Power +5 V	S3	V ₀₂ + output, isolated from main output	Aux output is		
Auxiliary Power +5 VRTN	S4	Aux output return; ground isolated from main output	floating	-	-
Logic Ground (LGND)	S5	Internally connected to Aux GND through 10Ω resistor. Wire LGND separately from Aux RTN and main output GND to minimize noise on signals and I^2C bus. Leave open if not used.	-	-	-
Output Inhibit R1	R1	PS active when pulled low (DC-DC stage off when left open)	LGND	<0.8 V >2.0 V	10 V 3.5 mA
V Sense +	R2	Open or connected to V_{01} + at the load Internally connected to V_{01} + via 100 Ω .	-	-	dV<3 Vpp 30 mA
V Sense -	R3	Open or connected to V_{01} - at the load Internally connected to V_{01} - via 100 Ω .	-	-	dV<3 Vpp 30 mA
Active Current Share	R4	This pin must be interconnected to pin R4 of all other paralleled PSUs for proper operation of active current share function	-	-	2V
Synchronized Startup (for paralleled units)	R5	Open or connected to synch startup circuit	V ₀₁ - at the OC		12V 2mA
V ₀₁ -	P1, P3, P5	Main output - pins	-	-	-
V ₀₁ +	P2, P4, P6	Main output + pins	-	-	_
INPUT CONNECTOR DESCRIPTION	OC PIN #	ТҮРЕ			
Protection Earth	P1	PE			
Phase	P2	L			
Neutral	P3	N			

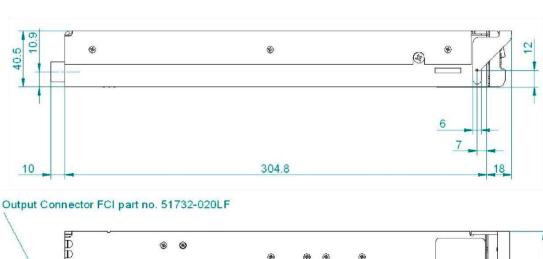


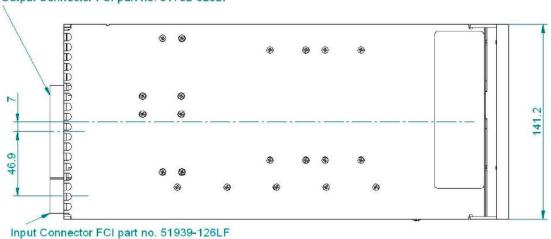
LED Indicator Functionality

CONDITION	POWER FAIL (AC OK)	OUTPUT GOOD (DC OK)	FAN FAIL AND OVER - TEMPERATURE
Normal Operation	Green	Green	OFF
Power Supply is Inhibited	Green	OFF	Amber
Input AC is Low	OFF	OFF	Amber
Input AC is Low or Missing	OFF	OFF	Amber/OFF
Over-Temperature	Green	OFF	Amber
Output Overload (In regulation)	Green	Green	OFF
Output Overloaded (Out of Regulation)	Green	OFF	OFF
Fan Not Running	Green	OFF	Amber
Power Supply Failed	OFF	OFF	OFF/ Amber

Mechanical Data

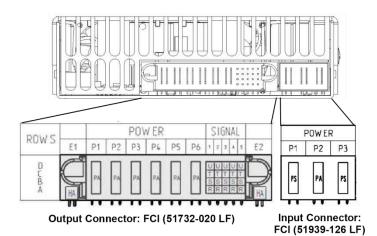
Mechanical Dimensions (W x H x D): 5.6" (141.2 mm) x 1.6" (40.5 mm) x 12" (304.8 mm)

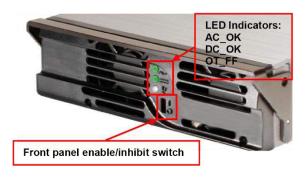






Input & Output Connector Description





FXP series front bezel showing LED indicators and recessed enable switch

Female ledge connector: Manufacturer: FCI

Output connector Part No.: 51762-106020000AA LF (Horizontal)
Output connector Part No.: 51742-106020000AA LF (Vertical)
Input connector Part No.: 51915-056LF (Horizontal)

Input connector Part No.: 51940-099LF (Vertical)

Information on availability under http://www.stkcheck.com/evs/fcielectronics/fcisearch.asp

Paralleling Front-Ends

For parallel use in minimal configuration systems, only the inhibit pins must be shorted to logic GND. All other pins can be left open. The power supplies will share the output current automatically (droop current share).

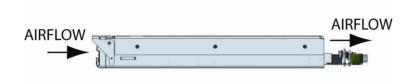
For parallel applications without I 2 C bus, but the use of all other features, it is recommended to connect all logic GND's on a backplane together, to connect all V_{o2} -, all V_{o2} + and to leave the internal GND's open.

The sense wires can be left open or connected to a common load point, the synch-start pin can be left open or connected to a synch-start circuit, the inhibit pins can be connected together or used individually. All I²C signals (T1-T5, S1, and S2) can be left open.

Use of a small foil capacitor > 3μ F directly at the power outputs of each unit is recommended in order to prevent voltage drops at the hot plug. For additional information on paralleling see the following Rack (Power Shelf) section.

Cooling

To achieve best cooling results sufficient airflow through the unit must be ensured. Do not block or obstruct the airflow at the rear of the unit by placing large components directly at the output connector.





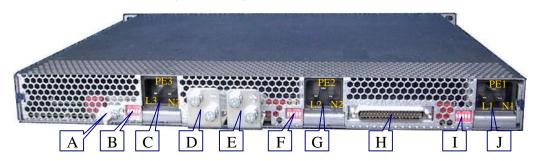
FXR-3-32G Power Shelf

- Each rack (power shelf) is 1U high with backplane and designed for up to three front-end models in parallel or in n+1 operation. Each power shelf has:
- Generous copper bus bars for low-loss current distribution.
- Output terminals with two M4-screws on each power tab.
- Two fast-on contacts for system earthing.
- Address coding over five pole DIP switch on each unit, 37-pin D-Sub connector with I²C-lines, monitoring signals and support functions.
- Provides a start-up synchronization circuit and EMV filters.
- Overall Mechanical Dimensions (W x H x D): 17.7" (449.6 mm) x 1.7" (43.1 mm) x 14" (355.6 mm)



FXR-3-32G Power Shelf Front View

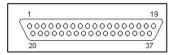
Output Connector Descriptions (FXR-3-32G)



LOCATION	DESCRIPTION	
Α	Earth connection	
В	5-bit DIP switch, pins 1,2,3 for I ² C addressing and pins 4,5 for Vo setting of PSU #3	ON APEMS
С	Mains connector of PSU #3	
D	Output 1 Minus	
E	Output 1 Plus	
F	5-bit DIP switch, pins 1,2,3 for I ² C addressing and pins 4,5 for Vo setting of PSU #2	ON APEMS 1 2 3 4 5
G	Mains connector of PSU #2	
Н	37-pin SUB-D connector, control, sense, check and Auxiliary power (Output 2)	
I	5-bit DIP switch, pins 1,2,3 for I ² C addressing and pins 4,5 for Vo setting of PSU #1	ON APEMS 1 2 3 4 5
J	Mains connector of PSU #1	



SUB-D Output Connector Pinout and Signal Specification



OUTPUT CONNECTOR DESCRIPTION	OC PIN	ТҮРЕ	SIGNAL REFERENCE	LOW LEVEL HIGH LEVEL	V MAX I MAX
Over-temperature / Fan Fail PSU1	1	OC-output, protected by 16 V Zener diode and a 10 Ω resistor in series	LGND	<0.4 V @ 20 mA Pull up	15 V 20 mA
Power Supply Present PSU 1	2	Parista (4 LO) and a lot LOND	LGND	Open Pull up	10 V
Power Supply Present PSU 2	3	Resistor (1 $k\Omega$) connected to LGND			10 mA
Spare	4				
Over-temperature / Fan Fail PSU 3	5	OC-output, protected by 16 V Zener diode and	LGND	<0.4 V @ 20 mA Pull up	15 V 20 mA
AC Fail / Power down warning PSU 3	6	a 10 Ω resistor in series			
Power Supply Present PSU 3	7	Resistor (1 $k\Omega$) connected to logic GND	LGND	Open Pull up	10 V 10 mA
DC Fail / Output voltage fault PSU 3	8	OC-output, protected by 16 V Zener diode and	LOND	<0.4 V @ 20 mA Pull up	15 V 20 mA
Overtemperature / Fan Fail PSU 2	9	a 10 Ω resistor in series	LGND		
SynchStart_A	10	Sync_start_A , Active high The signals of several racks can be connected together in such a way that all supplies will be inhibited until the last supply has recovered from its overcurrent condition	LGND	<7V off < 9V	15V 10mA
Open	11				
Output inhibit PSU 1-3	12	DC-DC stage ON when pin is open or connected to LGND DC-DC stage OFF when pin is connected on high potential	LGND	<0.8 V >2.0 V	10 V 3.5 mA
V sense +	13	Open or connected to $V_{01}+$ at the load Internally (PSU) connected to $V_{01}+$ over 100 Ω	V _{O1} +		dV < 3 Vpp 30 mA
V sense -	14	Open or connected to V_{01} - at the load Internally (PSU) connected to V_{01} - over 100 Ω	V ₀₁ -		dV < 3 Vpp 30 mA
Open	15				
NC	16				
NC	17				
NC	18				
NC	19				
AC Fail/ Power-down warning PSU 1	20		LGND	<0.4 V @ 20 mA Pull up	
DC Fail/ Output voltage fault PSU 1	21	OC-output, protected by 16 V Zener diode and			15 V 20 mA
AC Fail/ Power-down warning PSU 2	22	a 10 Ω resistor in series			
DC Fail/ Output voltage fault PSU 2	23				
SDA, I ² C data line	24	I ² C compatible signal	LGND	5 V or 3.3 V logic	
SCL, I ² C clock line	25	I ² C compatible signal	LGND	5 V or 3.3 V logic	
V_{O2} + = +5 V (Auxiliary power)	26	V ₀₂ + Aux output, insulated from main output	Aux output is		
V_{O2} - = +5 VRTN (Auxiliary power)	27	V ₀₂ - Aux output, insulated from main output	isolated supply		

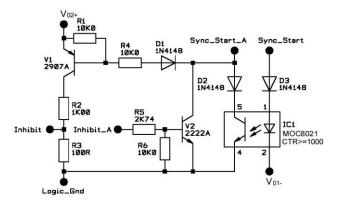


Logic Gnd (LGND)	28	Wire separately from auxiliary and main output GND to minimize noise and avoid voltage drops on signal- and I ² C return. Leave open if not used.	Internally connected to V ₀₂ - Auxiliary GND via 10 Ω	
Active curretnt share	29	This pin must be interconnected to all other parallel shelfs for proper operation of active current share function.		2V
NC	30			
NC	31			
NC	32			
NC	33			
NC	34			
Internal Ground PSU1	35	Used only for ADDRx and V ₀₁ set. Do not connect the internal grounds in the system with several units.	Connected to	
Internal Ground PSU2	36		V _{O1} - line before	
Internal Ground PSU3	37		the output filter	

Synchronized Start-Up Circuit for Paralleling Operation

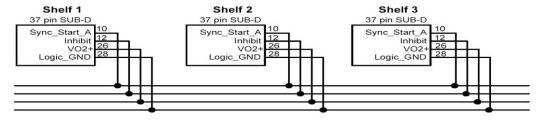
The FXP1500-32G power supply exhibit an overcurrent hiccup behavior. This means if either of these supplies reaches an overcurrent limit, the output voltage will immediately turn OFF and after a delay turn ON again. In parallel use, all power supplies have to start synchronized because of the internal hiccup behavior. Otherwise, the supply which has reached overcurrent first will go to hiccup; this will overload the other supplies, which then will also go to hiccup. When the first supply has recovered from hiccup (hiccup dead time), the others remain in hiccup. This will immediately drive the first one into hiccup once again. This means that without a start-up circuit, a system with several power supplies can never recover from an overload condition or start-up into full load.

The following additional circuit, required to reach synchronized startup, is already implemented inside the FXR-3-32G shelf.



Synch Start-up Connection between Shelves

The following connection between the shelves is required to achieve a parallel operation. The synch-start circuits inside the shelves inhibit all power supplies until the last one has recovered from its overcurrent condition and then synchronize the restart of the outputs.



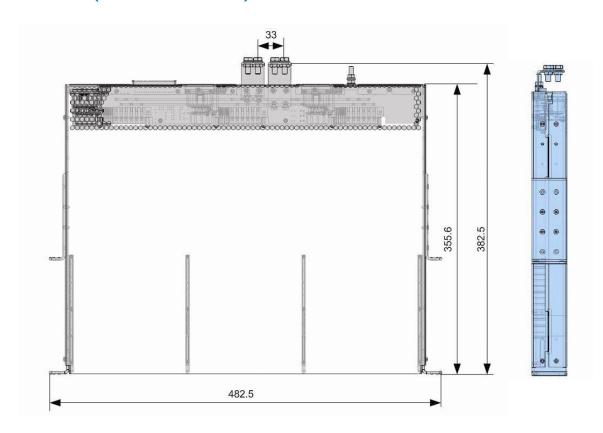


Synch Start-up Circuit Description

DESCRIPTION	PIN LOCATION, DEFINITION	ТҮРЕ	SIGNAL REFERENCE	LOW LEVEL HIGH LEVEL	V MAX I MAX
Auxiliary power +5 V (Output 2)	26	$V_{\text{O2}}+$, Aux output, insulated from main output			
Logic ground	28	Logic_GND , Internally connected over 10 Ω to $V_{\text{O2}^-},$ (Auxiliary power ground (Output 2))	Internally connected over 10 Ω to V _{O2} -		
Output inhibit_A PSU 1-3	12	Inhibit_A, DC-DC stage ON when pin is open or connected to LGND DC-DC stage OFF when pin is connected on high potential	LGND	<0.8 V >2.0 V	10 V 3.5 mA
Synch. Startup 1 PSU 1-3	R5 (at PSU OC)	The synch_start pin is connected to the over- current signal of the PSU1-3. In the case of an overcurrent shutdown, this signal goes high.	Vo1-	<7V off > 9V	15V 10mA
Synch. Startup_A Rack FXR-3-32G 1-N Pin on the D-Sub connector on the backplane	10	Sync_start_A, Active high The signals of several racks can be connected together in such a way that all supplies will be inhibited until the last supply has recovered from its overcurrent condition.	LGND		

NOTE: The Sync-Start pins can be wired together only if the power supplies are connected with a minimal voltage drop on power ground as achieved on a backplane with massive copper bus bars. If there is a less ideal connection, it is recommended to use an opto-coupler for each unit (IC1, D3, D2).

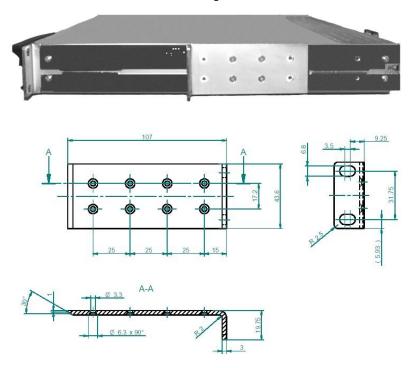
Mechanical Data (FXR-3-32G Power Shelf)



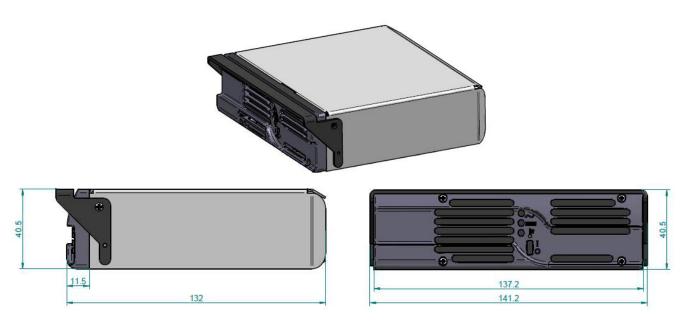


Accessories

Center Angular Brackets are set in the middle for shelf mounting:



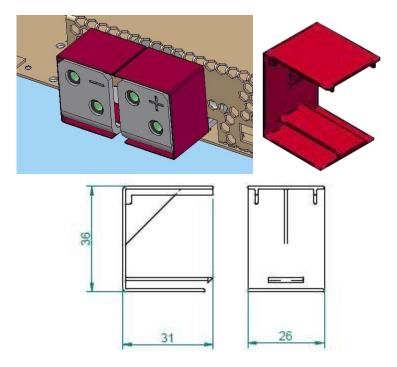
Center Angular Bracket sets can be ordered: Bel Power Solutions part no.: HZZ01222 Note: Each Center Angular Bracket set contains 2 brackets and 8 screws. Filler for covering of the empty shelf slots



Filler can be ordered: Bel Power Solutions part no.: XAK.00043.0



Plastic cover set for the bus bars:



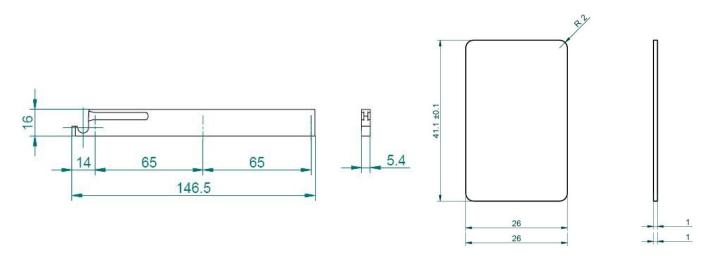
Plastic cover set can be ordered: Bel Power Solutions part no.: XEB.00031.0

Note1: Available upon special request. Note2: Each plastic cover set contains 2pcs.

Fulcrum

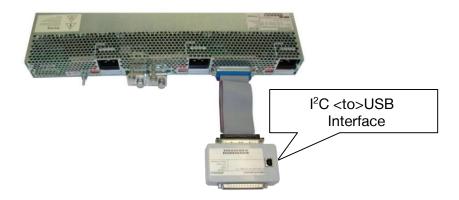
The handle has been designed to allow easy plug-in and -out in a rack system. The handle (lever) fits into a counter piece (fulcrum) which is fixed to the bottom of the rack. During the plug, the fulcrum holds the unit down and guides it towards the output connector. The Bel Power Solutions part number of the fulcrum and its associated mounting accessories is: HZZ01223.

Individual fulcrum sets can be also ordered: Bel Power Solutions part no.: HZZ01223. Note: Each HZZ01223 set contain 2 fulcrums, 2 supports, and mounting accessories.





I²C to USB Interface HZZ02002G



I²C Management Software: All FNP and FXP front-ends can be controlled via Bel Power Solutions GUI-driven I²C Management software and an I²C-to-USB interface (P/N HZZ02002G). An I²C Programming Manual describes the complete range of parameters that can be programmed to the FXP1500/1800 front-ends. This manual is available by searching on "FXP1500" at www.belpowersolutions.com.

For more information on these products consult: tech.support@psbel.com

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